

SF1605FCT THRU SF1660FCT

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SF1605FCT THRU SF1660FCT

16A Super Fast Recovery Rectifiers - 50V-600V

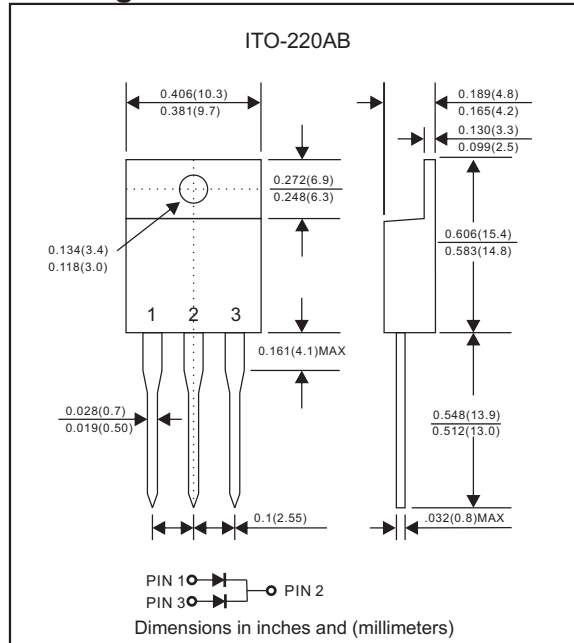
Features

- Dual rectifier construction, positive centetap, offer 8.0A half wave and 16.0A full wave rectification
- High surge current capability.
- Super fast recovery time for switching mode application.
- Low power loss.
- Glass passivated chip junctions.
- Lead-free parts meet environmental standards of MIL-STD-19500/228
- Suffix "-H" indicates Halogen-free parts, ex. SF1605FCT-H.

Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : JEDEC ITO-220AB molded plastic body over passivated chip
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guaranteed
- Polarity: As marked
- Mounting Position : Any
- Weight : Approximated 1.70 gram

Package outline



Maximum ratings (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOLS	SF1605FCT	SF1610FCT	SF1620FCT	SF1640FCT	SF1660FCT	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	V
Maximum average forward rectified current	I_o	16					A
Peak forward surge current 8.3ms single half sine-wave(JEDEC method)	I_{FSM}	125					A
Operating junction temperature range	T_J	-55 to +150					$^{\circ}\text{C}$
Storage temperature range	T_{STG}	-65 to +175					$^{\circ}\text{C}$

Electrical Characteristics (AT $T_A=25^{\circ}\text{C}$ unless otherwise noted)

PARAMETER	SYMBOLS	SF1605FCT	SF1610FCT	SF1620FCT	SF1640FCT	SF1660FCT	UNIT
Maximum forward voltage per leg at $I_F=8A$	V_F	0.98			1.30	1.70	V
Maximum DC reverse current at $T_J=25^{\circ}\text{C}$ at rated DC blocking voltage per leg at $T_J=125^{\circ}\text{C}$	I_R				5.0 250		μA μA
Maximum reverse recovery time per leg (Note 1)	t_{rr}				35		ns

Thermal Characteristics

PARAMETER	SYMBOLS	SF1605FCT	SF1610FCT	SF1620FCT	SF1640FCT	SF1660FCT	UNIT
Typical thermal resistance junction to case per leg	$R_{\theta JC}$	2.5					$^{\circ}\text{C}/\text{W}$

Note 1: Reverse recovery time test condition, $I_F=0.5A$, $I_R=1.0A$, $I_{RR}=0.25A$

Rating and characteristic curves (SF1605FCT THRU SF1660FCT)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

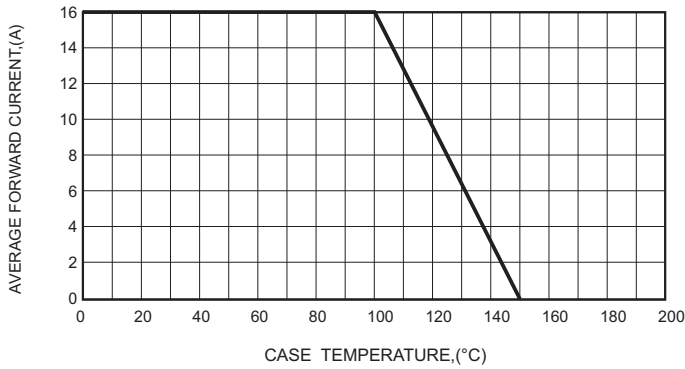


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

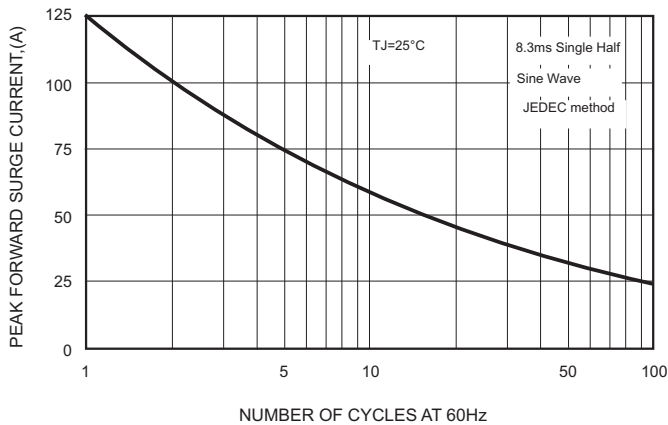


FIG.2-TYPICAL FORWARD CHARACTERISTICS

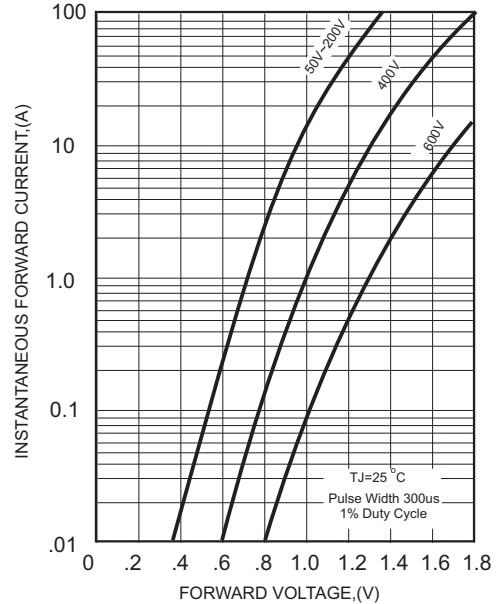


FIG.4 - TYPICAL REVERSE CHARACTERISTICS

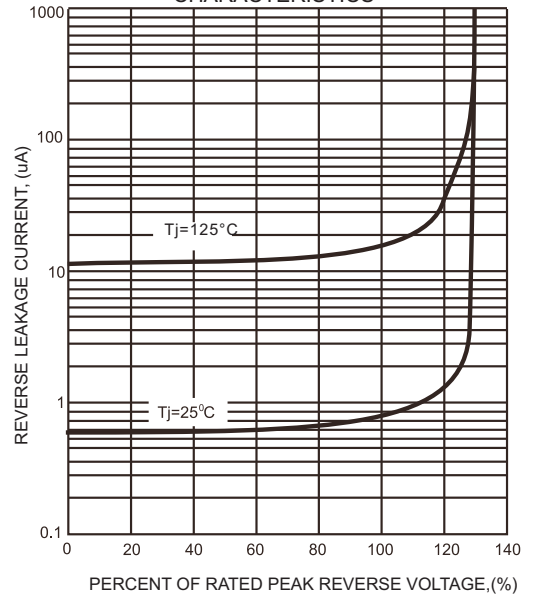
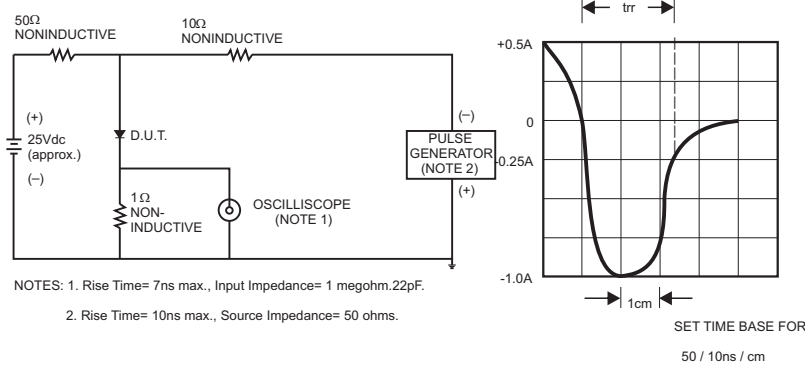


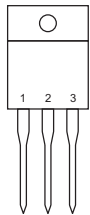
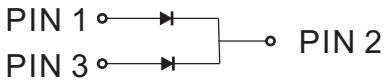
FIG.5- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm.22pF.
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

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Pinning information

Pin	Simplified outline	Symbol
Pin1 anode Pin2 cathode Pin3 anode		

Marking

Type number	Marking code
SF1605FCT	SF1605FCT
SF1610FCT	SF1610FCT
SF1620FCT	SF1620FCT
SF1640FCT	SF1640FCT
SF1660FCT	SF1660FCT

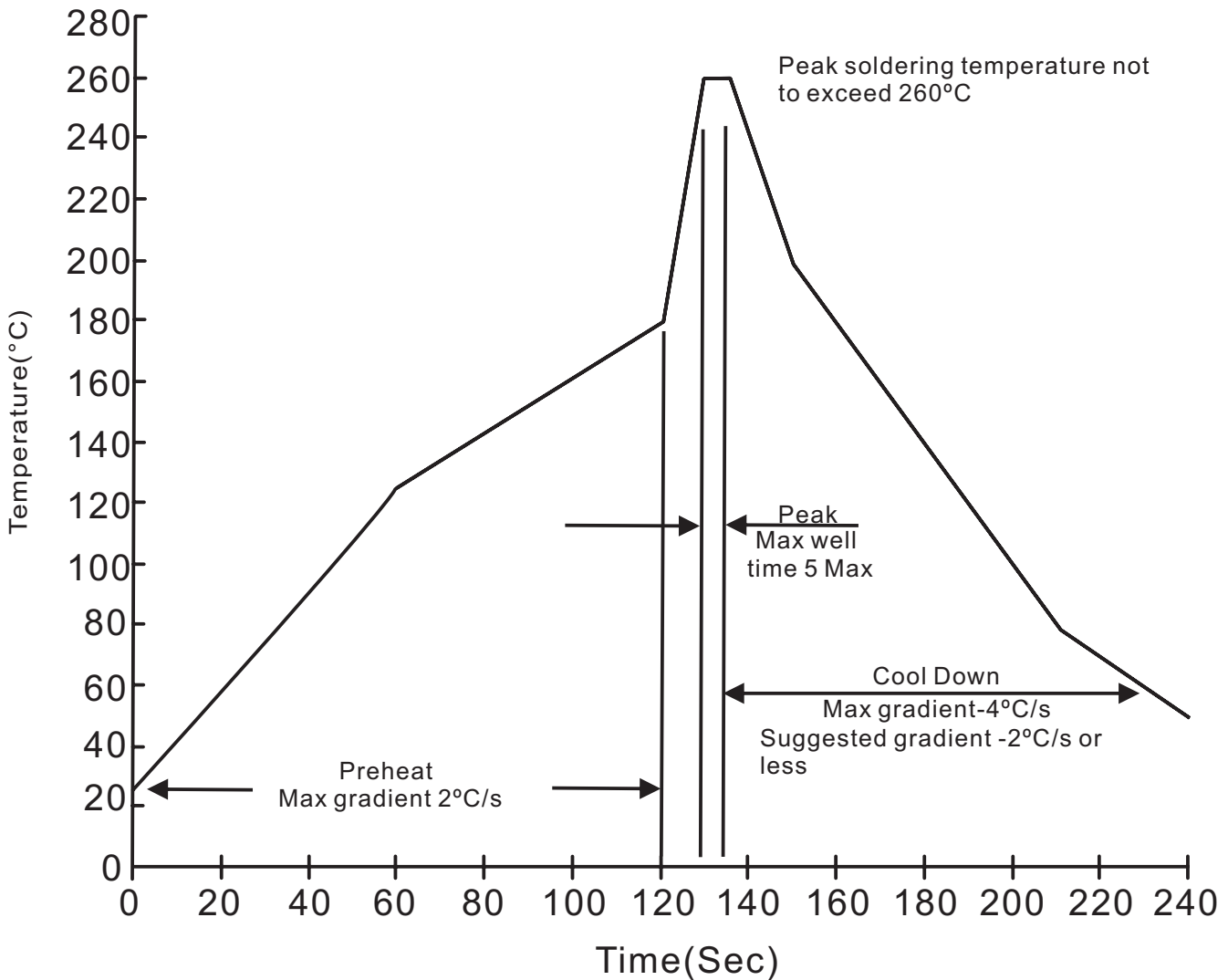
Tube packing

PACKAGE	TUBE (pcs)	TUBE SIZE (m/m)	BOX (pcs)	INNER BOX (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
ITO-220AB	50	525*32*7.0	1000	555*150*40	580*230*175	5,000	15.0

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Suggested thermal profiles for soldering processes

1. Lead free temperature profile wave-soldering



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High reliability test capabilities

Item Test	Conditions	Reference
1. Solder Resistance	at $260\pm 5^{\circ}\text{C}$ for $10\pm 2\text{sec}$. immerse body into solder $1/16''\pm 1/32''$	MIL-STD-750D METHOD-2031
2. Solderability	at $245\pm 5^{\circ}\text{C}$ for 5 sec.	MIL-STD-202F METHOD-208
3. High Temperature Reverse Bias	$V_R=80\%$ rate at $T_J=150^{\circ}\text{C}$ for 168 hrs.	MIL-STD-750D METHOD-1038
4. Forward Operation Life	Rated average rectifier current at $T_A=25^{\circ}\text{C}$ for 500hrs.	MIL-STD-750D METHOD-1027
5. Intermittent Operation Life	$T_A = 25^{\circ}\text{C}$, $I_F = I_o$ On state: power on for 5 min. off state: power off for 5 min. on and off for 500 cycles.	MIL-STD-750D METHOD-1036
6. Pressure Cooker	$15P_{SIG}$ at $T_A=121^{\circ}\text{C}$ for 4 hrs.	JESD22-A102
7. Temperature Cycling	-55°C to $+125^{\circ}\text{C}$ dwelled for 30 min. and transferred for 5min. total 10 cycles.	MIL-STD-750D METHOD-1051
8. Forward Surge	8.3ms single half sine-wave , one surge.	MIL-STD-750D METHOD-4066-2
9. Humidity	at $T_A=85^{\circ}\text{C}$, RH=85% for 1000hrs.	MIL-STD-750D METHOD-1021
10. High Temperature Storage Life	at 175°C for 1000 hrs.	MIL-STD-750D METHOD-1031